

**Product Texts**

Common features of Delrin® acetal resins include mechanical and physical properties such as high mechanical strength and rigidity, excellent fatigue and impact resistance, as well as resistance to moisture, gasoline, lubricants, solvents, and many other neutral chemicals. Delrin® acetal resins also have excellent dimensional stability and good electrical insulating characteristics. They are naturally resilient, self-lubricating, and available in a variety of colors and speciality grades.

Delrin® acetal resin typically is used in demanding applications in the automotive, domestic appliances, sports, industrial engineering, electronics, and consumer goods industries.

**Delrin® 500T is a toughened, medium viscosity acetal homopolymer resin for injection molding with impact resistance similar to Delrin® 100. It can be used in parts requiring noise reduction.**

Processing/Physical Characteristics	Value	Unit	Test Standard
<b>ISO Data</b>			
<sup>[C]</sup> Melt volume-flow rate, MVR	10	cm <sup>3</sup> /10min	ISO 1133
Temperature	190	°C	-
Load	2.16	kg	-
<sup>[C]</sup> Molding shrinkage, parallel	1.5	%	ISO 294-4, 2577
<sup>[C]</sup> Molding shrinkage, normal	1.6	%	ISO 294-4, 2577
<b>ASTM Data</b>			
Melt Flow Index, MFI	5.5	g/10min	ASTM D 1238
Mold Shrinkage, MD	0.0145	mm/mm	ASTM D 955
Mold Shrinkage, TD	0.0145	mm/mm	ASTM D 955

[C]: CAMPUS

Mechanical properties	Value	Unit	Test Standard
<b>ISO Data</b>			
<sup>[C]</sup> Tensile Modulus	2300	MPa	ISO 527
<sup>[C]</sup> Yield stress	55	MPa	ISO 527
<sup>[C]</sup> Yield strain	18	%	ISO 527
<sup>[C]</sup> Nominal strain at break	35	%	ISO 527
<sup>[C]</sup> Tensile creep modulus, 1h	2300	MPa	ISO 899-1
<sup>[C]</sup> Tensile creep modulus, 1000h	1200	MPa	ISO 899-1
<sup>[C]</sup> Charpy impact strength, +23°C	N	kJ/m <sup>2</sup>	ISO 179/1eU
<sup>[C]</sup> Charpy impact strength, -30°C	330	kJ/m <sup>2</sup>	ISO 179/1eU
<sup>[C]</sup> Charpy notched impact strength, +23°C	13	kJ/m <sup>2</sup>	ISO 179/1eA
<sup>[C]</sup> Charpy notched impact strength, -30°C	8.5	kJ/m <sup>2</sup>	ISO 179/1eA
<b>ASTM Data</b>			
Tensile Modulus	2400	MPa	ASTM D 638
Tensile Strength at Yield	53	MPa	ASTM D 638
Elongation at Yield	15	%	ASTM D 638
Elongation at Break	75	%	ASTM D 638
Flexural Modulus	2250	MPa	ASTM D 790
Rockwell Hardness	R 117	-	ASTM D 785
Izod Impact notched, 1/8 in	128	J/m	ASTM D 256
Izod Impact notched, Low-Temperature	106	J/m	ASTM D 256
Temperature	-40	°C	-

[C]: CAMPUS

Thermal properties	Value	Unit	Test Standard
<b>ISO Data</b>			
<sup>[C]</sup> Melting temperature, 10°C/min	178	°C	ISO 11357-1/-3
<sup>[C]</sup> Temp. of deflection under load, 1.80 MPa	80	°C	ISO 75-1/-2
<sup>[C]</sup> Temp. of deflection under load, 0.45 MPa	145	°C	ISO 75-1/-2
<sup>[C]</sup> Vicat softening temperature, B	140	°C	ISO 306
<sup>[C]</sup> Coeff. of linear therm. expansion, parallel	130	E-6/K	ISO 11359-1/-2
<sup>[C]</sup> Coeff. of linear therm. expansion, normal	120	E-6/K	ISO 11359-1/-2
<sup>[C]</sup> Burning Behav. at 1.5 mm nom. thickn.	HB	class	IEC 60695-11-10
Thickness tested	1.5	mm	-
Yellow Card available	yes	-	-
<sup>[C]</sup> Burning Behav. at thickness h	HB	class	IEC 60695-11-10
Thickness tested	0.8	mm	-
Yellow Card available	yes	-	-

**ASTM Data**

UL 94 Flame rating	<b>HB</b>	-	UL 94
Thickness tested	<b>1.5</b>	mm	-
Coefficient of Thermal Expansion, MD	<b>126</b>	E-6/K	ASTM D 696
Coefficient of Thermal Expansion, TD	<b>118</b>	E-6/K	ASTM D 696
DTUL @ 66 psi	<b>157</b>	°C	ASTM D 648
DTUL @ 264 psi	<b>79</b>	°C	ASTM D 648
Melting Temperature	<b>178</b>	°C	ASTM D 3418

[C]: CAMPUS

**Electrical properties**

	<b>Value</b>	<b>Unit</b>	<b>Test Standard</b>
<b>ISO Data</b>			
<sup>[C]</sup> Relative permittivity, 100Hz	<b>3.6</b>	-	IEC 62631-2-1
<sup>[C]</sup> Relative permittivity, 1MHz	<b>3.6</b>	-	IEC 62631-2-1
<sup>[C]</sup> Dissipation factor, 1MHz	<b>160</b>	E-4	IEC 62631-2-1
<sup>[C]</sup> Volume resistivity	<b>&gt;1E13</b>	Ohm*m	IEC 62631-3-1
<sup>[C]</sup> Surface resistivity	<b>1E15</b>	Ohm	IEC 62631-3-2
<sup>[C]</sup> Comparative tracking index	<b>600</b>	-	IEC 60112

**ASTM Data**

Dielectric Strength, Short Time	<b>15.5</b>	kV/mm	ASTM D 149
Dissipation Factor, 1 MHz	<b>0.016</b>	-	ASTM D 150
Dielectric Constant, 1 MHz	<b>3.9</b>	-	ASTM D 150
Surface Resistivity	<b>1E15</b>	Ohm	ASTM D 257
Volume Resistivity	<b>1E15</b>	Ohm*cm	ASTM D 257

[C]: CAMPUS

**Other properties**

	<b>Value</b>	<b>Unit</b>	<b>Test Standard</b>
<sup>[C]</sup> Water absorption	<b>0.82</b>	%	Sim. to ISO 62
<sup>[C]</sup> Humidity absorption	<b>0.21</b>	%	Sim. to ISO 62
<sup>[C]</sup> Density	<b>1380</b>	kg/m <sup>3</sup>	ISO 1183
Water Absorption, 24hr	<b>0.41</b>	%	ASTM D 570
Water Absorption, Equilibrium	<b>0.27</b>	%	ASTM D 570
Density	<b>1390</b>	kg/m <sup>3</sup>	ASTM D 792

[C]: CAMPUS

**Characteristics****Processing**

Injection Molding, Pipe/Tube Extrusion, Profile Extrusion, Wire/Cable Extrusion, Other Extrusion

**Delivery form**

Pellets, Natural Color

**Additives**

Lubricants, Release agent

**Special Characteristics**

High impact or impact modified

**Features**

Weldable, Homopolymer

**Regional Availability**

North America, Europe, Asia Pacific, South and Central America, Near East/Africa